



843.40341CX1

TFW

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant(s): Y. SAITOH et al
Serial No.: 10/764,539
Filed: January 27, 2004
For: SEMICONDUCTOR WAFER, SEMICONDUCTOR CHIP, AND
MANUFACTURING METHOD OF SEMICONDUCTOR CHIP
Group: 2818
Examiner: T. NGUYEN

AMENDMENT

MS: AMENDMENTS

Commissioner For Patents
POB 1450
Alexandria, VA 22313-1450

October 29, 2004

Sir:

In response to the Office Action dated July 29, 2004, please amend the above-identified application as listed below and as set forth on the following pages:

Amendments to the Claims;

Remarks are included following the Amendment.